

Characteristics

I_o	1.0	A
V_{RRM}	50~1000	V
I_{FSM}	30.0	A
V_F	1.30	V

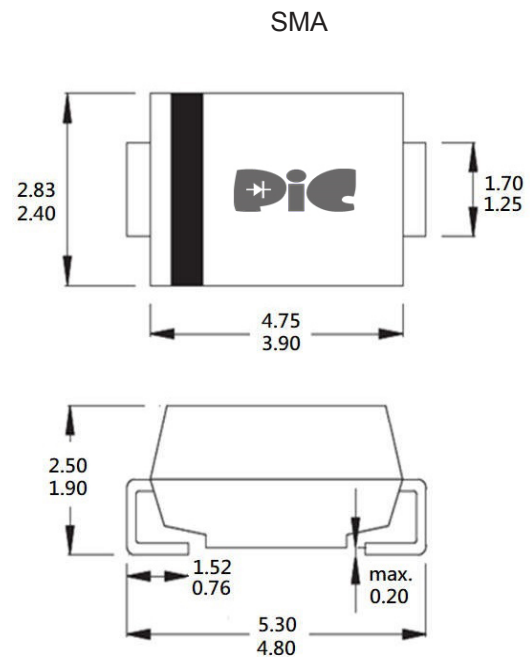
Features

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- For surface mounted applications
- Fast switching for high efficiency
- Low reverse leakage
- Built-in strain relief, ideal for automated placement
- High forward surge current capability
- High temperature soldering guaranteed: 260°C/10 seconds at terminals
- Glass passivated chip junction.

Mechanical Data

- Case: JEDEC SMA molded plastic body over passivated chip
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end

Package Outline Dimensions



Unit : millimeters

Maximum Ratings (TA=25°C unless otherwise noted)

	Symbol	RS1A	RS1B	RS1D	RS1G	RS1J	RS1K	RS1M	UNITS
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	Volts
Max. average forward rectified current at TL=90°C	$I_{(AV)}$	1.0							Amps
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	30.0							Amps
Maximum instantaneous forward voltage at 1.0A	V_F	1.3							Volts
Maximum DC reverse current TA=25°C	I_R	5.0							A
Maximum reverse recovery time (NOTE 1)	t_{rr}	150				250	500		ns
Typical junction capacitance (NOTE 2)	C_J	60.0							pF
Typical thermal resistance (NOTE 3)	R_{qJA}	48.0							°C/W
Operating junction and storage temperature range	T_J, T_{STG}	-55~+150							°C

Notes:

- (1) Reverse recovery condition $I_F=0.5A, I_R=1.0A, I_{rr}=0.25A$
- (2) Measured at 1MHz and applied reverse voltage of 4.0V D.C.
- (3) 3.P.C.B. mounted with 0.2x0.2"(5.0x5.0mm) copper pad areas

Rating and Characteristics Curves

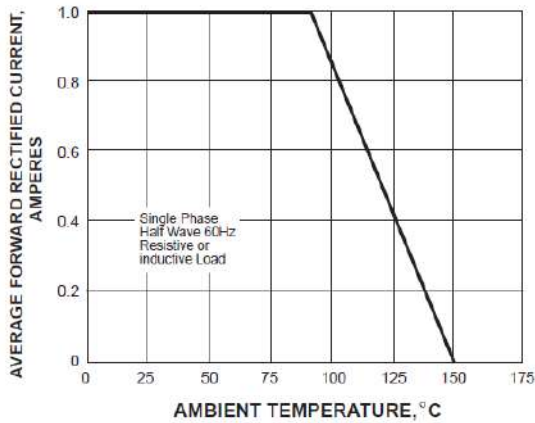


Fig. 1 Forward Current Derating Curve

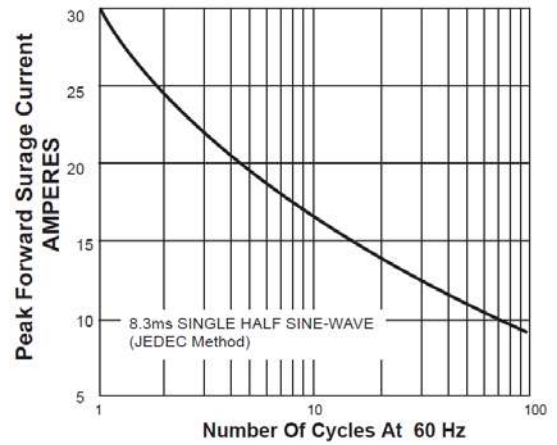


Fig. 2 Typical Junction Capacitance

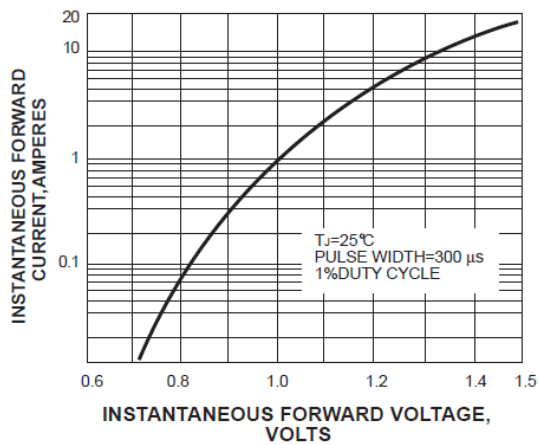


Fig. 3 Typical Reverse Characteristics

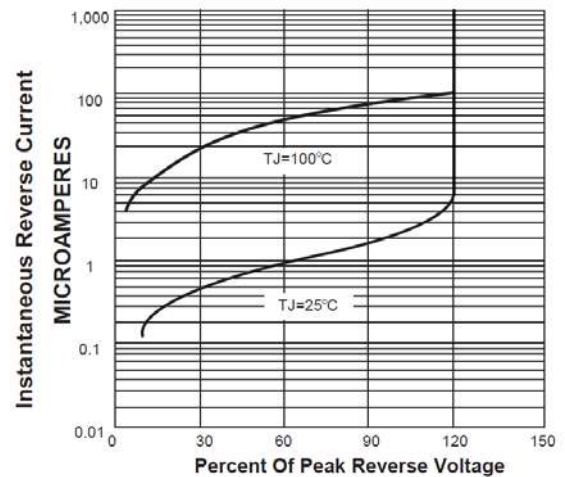


Fig. 4 Typical Forward Characteristics

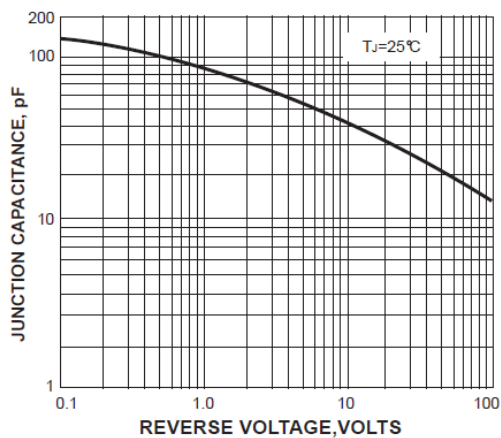


Fig. 5 Typical Reverse Characteristics

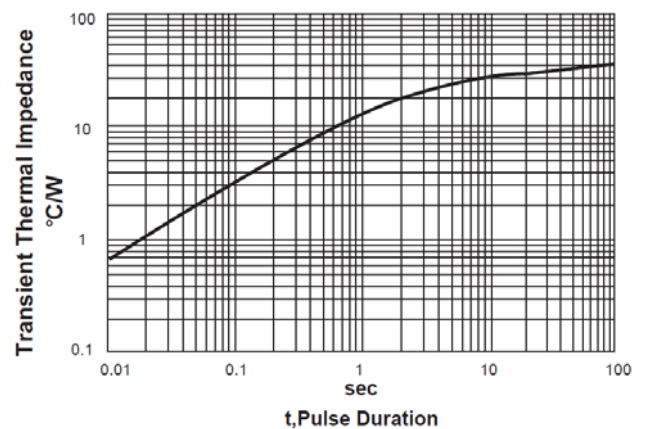
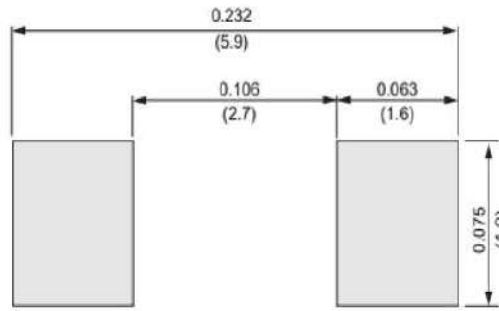


Fig. 6 Typical Transient Thermal Impedance

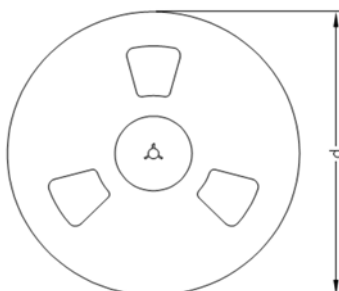
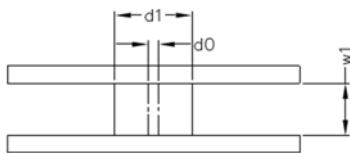
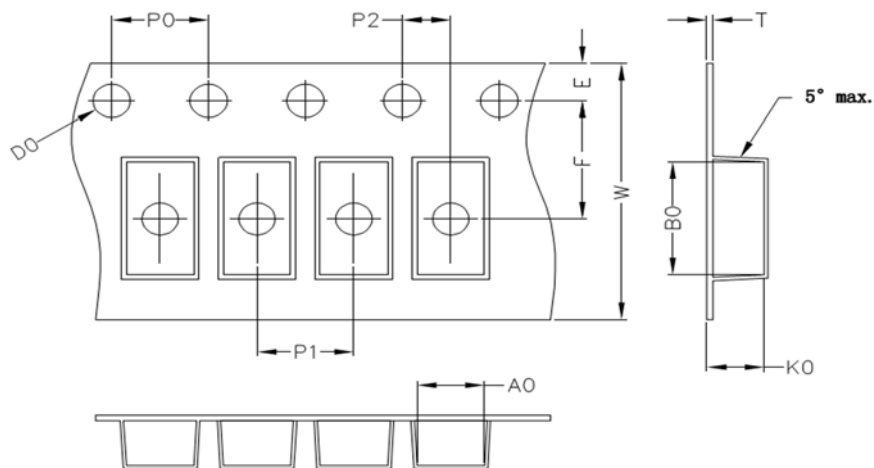
Pad Layout



Unit:mm

Packaging Specifications

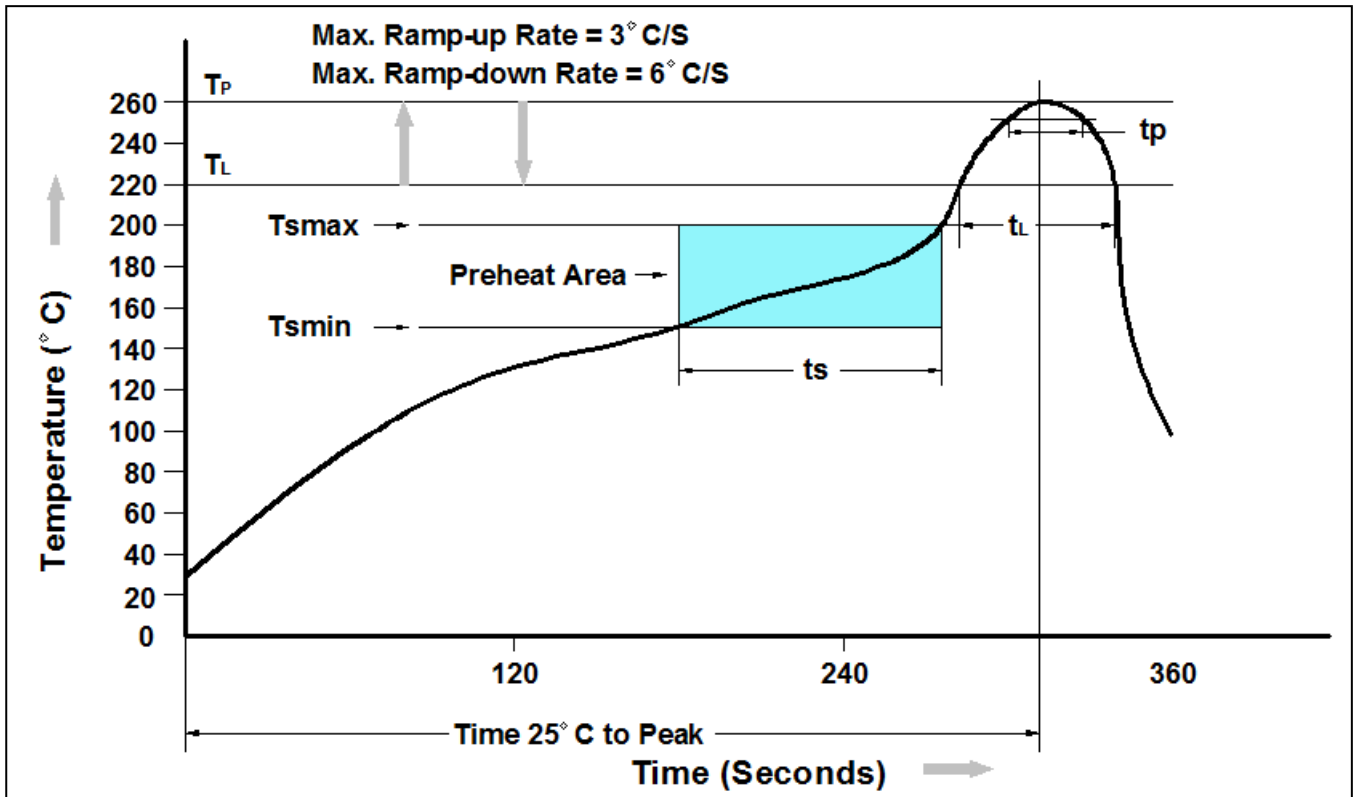
Package	A0 (mm)	B0 (mm)	K0 (mm)	D0 (mm)	E (mm)	F (mm)	P0 (mm)	P1 (mm)	P2 (mm)	T (mm)	W (mm)
SMA	2.8±0.1	5.33±0.1	2.36±0.1	1.55±0.1	1.75±0.1	5.50±0.1	4.0±0.1	4.0±0.01	2±0.1	0.25±0.1	9.4±0.1
SMB	3.8±0.1	5.40±0.1	2.45±0.1	1.55±0.1	1.75±0.1	5.50±0.1	4.0±0.1	8.0±0.01	2±0.1	0.25±0.1	9.4±0.1
SMC	6.05±0.1	8.31±0.1	2.54±0.1	1.55±0.1	1.75±0.1	7.50±0.1	4.0±0.1	8.0±0.05	2±0.1	0.25±0.1	12±0.1



Package	D1 (mm)	D0 (mm)	W1 (mm)	D (mm)
SMA	75	13.5	13.5	330
SMB	75	13.5	13.5	330
SMC	75	13.5	17.0	330

NOTE : The tolerance of reel is ±2mm

Recommend IR Reflow Soldering Thermal Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (T_{smin})	150°C
Temperature Max. (T_{smax})	200°C
Time (t_s) from (T_{smin} to T_{smax})	60-120 seconds
Average Ramp-up Rate (t_L to t_P)	3°C/second max.
Liquidous Temperature (T_L)	217°C
Time (t_L) Maintained Above (T_L)	60 – 150 seconds
Peak Temperature	260°C +0°C / -5°C
Time (t_P) within 5°C of actual Peak Temperature	30 seconds
Ramp-down Rate (T_P to T_L)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

Ordering Information

Part Number	Description	Quantity
RS1A~RS1M	SMA Reel	5000 pcs

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